



30V +175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI

Product Summary

BV _{DSS}	R _{DS(ON)}	Ι _D T _C = +25°C
30V	$1.6m\Omega @ V_{GS} = 10V$	240A

Description

This new generation N-Channel Enhancement Mode MOSFET is designed to minimize R_{DS(ON)}, yet maintain superior switching performance. This device is ideal for use in power management and load switch.

Pin1

Applications

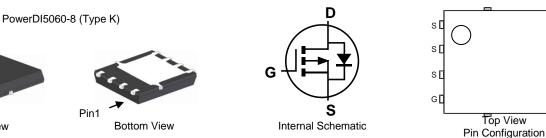
- **DC-DC** Converters
- Load Switch

Features

- Thermally Efficient Package Cooler Running Applications •
- <1.1mm Package Profile Ideal for Thin Applications
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: PowerDI5060-8 (Type K)
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208@3
- Weight: 0.097 grams (Approximate)



Ordering Information (Note 4)

Part Number Case Packaging	
- and a second	
DMTH3002LPS-13 PowerDI5060-8 (Type K) 2,500/Tape & Reel	

1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"

and Lead-free.

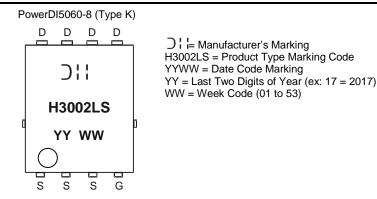
Notes:

Top View

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



PowerDI is a registered trademark of Diodes Incorporated.

D

ΠD

ПD

Πр



Maximum Ratings (@T_C = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	30	V
Gate-Source Voltage	V _{GSS}	±16	V
Continuous Drain Current, V_{GS} = 10V (Note 7)	ID	240 240	А
Maximum Continuous Body Diode Forward Current (No	Is	100	A
Pulsed Drain Current (380µs Pulse, Duty Cycle = 1%)	I _{DM}	400	A
Pulsed Continuous Body Diode Forward Current (380µs	I _{SM}	400	A
Avalanche Current, L=3mH (Note 8)	I _{AS}	15	A
Avalanche Energy, L=3mH (Note 8)	E _{AS}	700	mJ

Thermal Characteristics (@T_C = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units
Total Power Dissipation (Note 5)	T _A = +25°C	PD	1.2	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{θJA}	103	°C/W
Total Power Dissipation (Note 6)	T _A = +25°C	PD	2.5	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R _{0JA}	51	°C/W
Total Power Dissipation (Note 7)	T _C = +25°C	PD	136	W
Thermal Resistance, Junction to Case (Note 7)		R _{0JC}	1.1	°C/W
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +175	°C

Electrical Characteristics (@T_C = +25°C, unless otherwise specified.)

			-			T (0 4)	
	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)				1			
Drain-Source Breakdown Voltage	BV _{DSS}	30	—	—	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	—	—	1	μA	$V_{DS} = 24V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	—	—	±100	nA	$V_{GS} = \pm 16V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)			-				
Gate Threshold Voltage	V _{GS(TH)}	1	—	2	V	$V_{DS} = V_{GS}, I_D = 1mA$	
Static Drain-Source On-Resistance	D	—	1.25	1.6	mΩ	$V_{GS} = 10V, I_D = 25A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	2	2.5	1117	V _{GS} = 4.5V, I _D = 25A	
Diode Forward Voltage	V _{SD}	_	0.8	1.1	V	$V_{GS} = 0V, I_{S} = 25A$	
DYNAMIC CHARACTERISTICS (Note 10)						÷	
Input Capacitance	CISS	—	5,000	—		$V_{DS} = 15V, V_{GS} = 0V,$ f = 1MHz	
Output Capacitance	C _{OSS}	_	2,660	_	pF		
Reverse Transfer Capacitance	C _{RSS}	_	300	_			
Gate Resistance	R _G	_	0.75	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Q _G	_	37	_		V _{DS} = 15V, I _D = 25A	
Total Gate Charge (V _{GS} = 10V)	Q _G	_	77	_			
Gate-Source Charge	Q _{GS}	_	10	_	nC		
Gate-Drain Charge	Q _{GD}	_	14	_			
Turn-On Delay Time	t _{D(ON)}		21	_		$V_{DD} = 15V, V_{GS} = 4.5V,$ $I_D = 25A, R_G = 4.7\Omega$	
Turn-On Rise Time	t _R	_	45	—			
Turn-Off Delay Time	t _{D(OFF)}	_	32	—	ns		
Turn-Off Fall Time	t _F	_	26	—			
Body Diode Reverse Recovery Time	t _{RR}	_	44	—	ns		
Body Diode Reverse Recovery Charge	Q _{RR}	_	52	_	nC	—I _S = 15A, di/dt = 100A/μs	

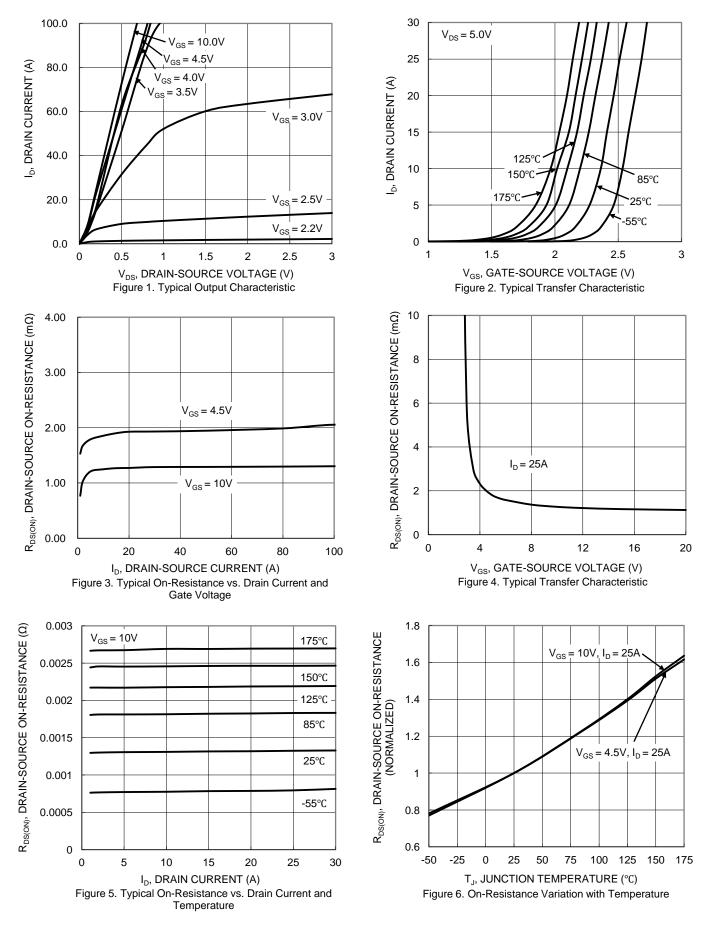
Notes:

Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.
Thermal resistance from junction to soldering point (on the exposed drain pad).

8. I_{AS} and E_{AS} rating are based on low frequency and duty cycles to keep $T_J = +25^{\circ}C$. 9. Short duration pulse test used to minimize self-heating effect. 10. Guaranteed by design. Not subject to product testing.

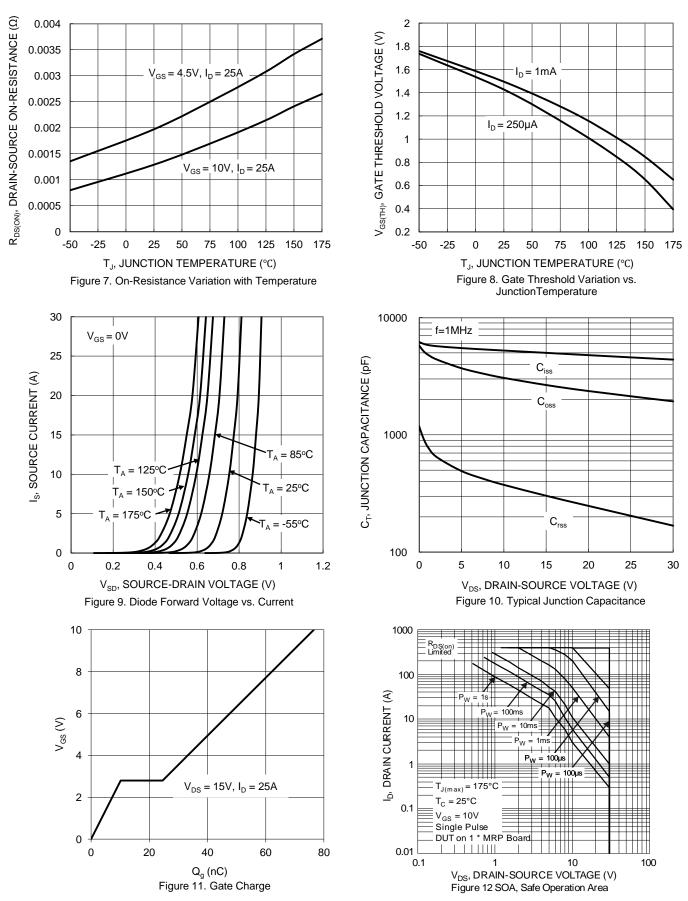


DMTH3002LPS



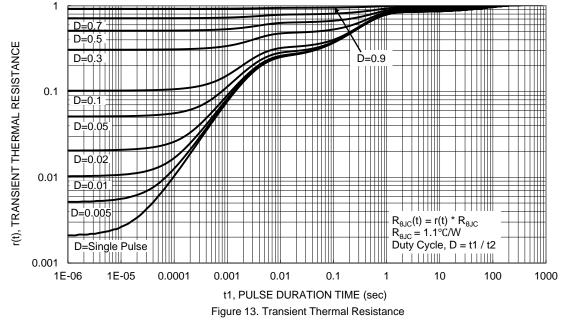


DMTH3002LPS





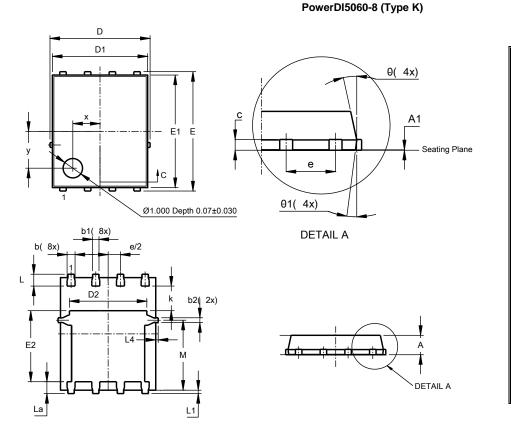
DMTH3002LPS





Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

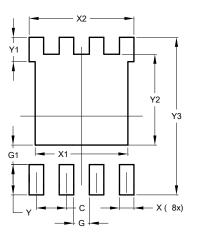


PowerDI5060-8							
(Туре К)							
Dim	Min	Max	Тур				
Α	0.90	1.10	1.00				
A1	0	0.05	0.02				
b	0.33	0.51	0.41				
b1	0.300	0.366	0.333				
b2	0.20	0.35	0.25				
c	0.23	0.33	0.277				
D	5.15 BSC						
D1	4.85	4.95	4.90				
D2	-	3.98					
Е	6.15 BSC						
E1	5.75	5.85	5.80				
E2	3.56	3.725	3.66				
E	1	.27BSC					
k	-	-	1.27				
L	0.51	0.71	0.61				
La	0.51	0.675	0.61				
L1	0.05	0.20	0.175				
L4	-	-	0.125				
Μ	3.50	3.71	3.605				
х	-	-	1.400				
у	-	-	1.900				
θ	10°	12°	11°				
θ1	6°	8°	7°				
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (Type K)



Dimensions	Value (in mm)		
Dimensions			
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	3.910		
X2	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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